

## 7A, 800V N-CHANNEL MOSFET

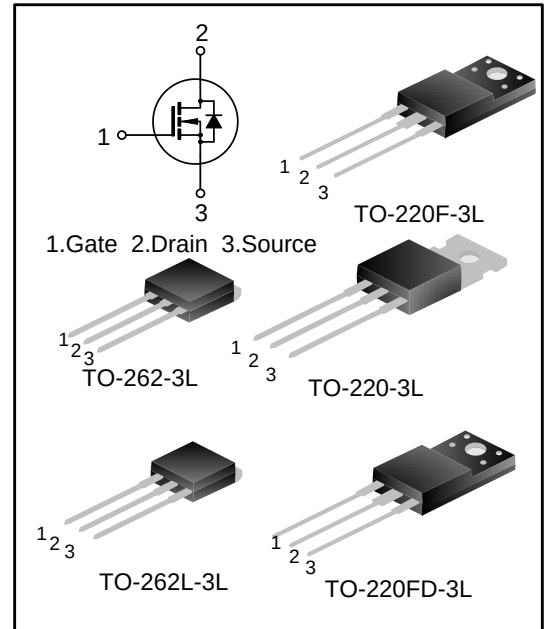
### GENERAL DESCRIPTION

SVF7N80T/F/KL/K/FD is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ high-voltage planar VDMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are widely used in AC-DC power supplies, DC-DC converters and H-bridge PWM motor drives.

### FEATURES

- ♦ 7A,800V, $R_{DS(on)}(typ.)=1.39\Omega@V_{GS}=10V$
- ♦ Low gate charge
- ♦ Low  $C_{rss}$
- ♦ Fast switching
- ♦ Improved dv/dt capability



### ORDERING INFORMATION

| Part No.  | Package     | Marking   | Hazardous Substance Control | Packing Type |
|-----------|-------------|-----------|-----------------------------|--------------|
| SVF7N80T  | TO-220-3L   | SVF7N80T  | Pb free                     | Tube         |
| SVF7N80F  | TO-220F-3L  | SVF7N80F  | Pb free                     | Tube         |
| SVF7N80KL | TO-262L-3L  | SVF7N80KL | Pb free                     | Tube         |
| SVF7N80K  | TO-262-3L   | SVF7N80K  | Pb free                     | Tube         |
| SVF7N80FD | TO-220FD-3L | SVF7N80FD | Pb free                     | Tube         |

## ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C UNLESS OTHERWISE NOTED)

| Characteristics                                               |                       | Symbol           | Ratings  |             |             | Unit |
|---------------------------------------------------------------|-----------------------|------------------|----------|-------------|-------------|------|
|                                                               |                       |                  | SVF7N80T | SVF7N80F/FD | SVF7N80KL/K |      |
| Drain-Source Voltage                                          |                       | V <sub>DS</sub>  | 800      |             |             | V    |
| Gate-Source Voltage                                           |                       | V <sub>GS</sub>  | ±30      |             |             | V    |
| Drain Current                                                 | T <sub>C</sub> =25°C  | I <sub>D</sub>   | 7.0      |             |             | A    |
|                                                               | T <sub>C</sub> =100°C |                  | 4.4      |             |             |      |
| Drain Current Pulsed                                          |                       | I <sub>DM</sub>  | 28.0     |             |             | A    |
| Power Dissipation(T <sub>C</sub> =25°C)<br>-Derate above 25°C |                       | P <sub>D</sub>   | 154      | 50          | 150         | W    |
|                                                               |                       |                  | 1.23     | 0.40        | 1.20        | W/°C |
| Single Pulsed Avalanche Energy(Note 1)                        |                       | E <sub>AS</sub>  | 534      |             |             | mJ   |
| Operation Junction Temperature Range                          |                       | T <sub>J</sub>   | -55~+150 |             |             | °C   |
| Storage Temperature Range                                     |                       | T <sub>stg</sub> | -55~+150 |             |             | °C   |

## THERMAL CHARACTERISTICS

| Characteristics                         | Symbol           | Ratings  |             |             | Unit |
|-----------------------------------------|------------------|----------|-------------|-------------|------|
|                                         |                  | SVF7N80T | SVF7N80F/FD | SVF7N80KL/K |      |
| Thermal Resistance, Junction-to-Case    | R <sub>θJC</sub> | 0.81     | 2.50        | 0.83        | °C/W |
| Thermal Resistance, Junction-to-Ambient | R <sub>θJA</sub> | 62.5     | 62.5        | 62.5        | °C/W |

## ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C UNLESS OTHERWISE NOTED)

| Characteristics                             | Symbol              | Test conditions                                                                        | Min. | Typ. | Max. | Unit |
|---------------------------------------------|---------------------|----------------------------------------------------------------------------------------|------|------|------|------|
| Drain -Source Breakdown Voltage             | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                                             | 800  | --   | --   | V    |
| Drain-Source Leakage Current                | I <sub>DSS</sub>    | V <sub>DS</sub> =800V, V <sub>GS</sub> =0V                                             | --   | --   | 1.0  | μA   |
| Gate-Source Leakage Current                 | I <sub>GSS</sub>    | V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V                                             | --   | --   | ±100 | nA   |
| Gate Threshold Voltage                      | V <sub>GS(th)</sub> | V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> =250μA                              | 2.0  | --   | 4.0  | V    |
| Static Drain- Source<br>On State Resistance | R <sub>DS(on)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A                                             | --   | 1.4  | 1.6  | Ω    |
| Gate Resistance                             | R <sub>g</sub>      | f=1MHz                                                                                 | --   | 4.6  | --   | Ω    |
| Input Capacitance                           | C <sub>iss</sub>    | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,<br>f=1.0MHz                                 | ---  | 1087 | ---  | pF   |
| Output Capacitance                          | C <sub>oss</sub>    |                                                                                        | --   | 104  | --   |      |
| Reverse Transfer Capacitance                | C <sub>rss</sub>    |                                                                                        | --   | 5.7  | --   |      |
| Turn-on Delay Time                          | t <sub>d(on)</sub>  | V <sub>DD</sub> =400V, R <sub>G</sub> =25Ω ,<br>I <sub>D</sub> =7.0A<br><br>(Note 2,3) | --   | 34   | --   | ns   |
| Turn-on Rise Time                           | t <sub>r</sub>      |                                                                                        | --   | 72   | --   |      |
| Turn-off Delay Time                         | t <sub>d(off)</sub> |                                                                                        | --   | 63   | --   |      |
| Turn-off Fall Time                          | t <sub>f</sub>      |                                                                                        | --   | 35   | --   |      |
| Total Gate Charge                           | Q <sub>g</sub>      | V <sub>DS</sub> =640V, I <sub>D</sub> =7.0A,<br>V <sub>GS</sub> =10V<br><br>(Note 2,3) | --   | 23   | --   | nC   |
| Gate-Source Charge                          | Q <sub>gs</sub>     |                                                                                        | --   | 7.0  | --   |      |
| Gate-Drain Charge                           | Q <sub>gd</sub>     |                                                                                        | --   | 9.0  | --   |      |

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Characteristics           | Symbol   | Test conditions               | Min. | Typ. | Max. | Unit    |
|---------------------------|----------|-------------------------------|------|------|------|---------|
| Continuous Source Current | $I_S$    | Integral Reverse P-N Junction | --   | --   | 7.0  | A       |
| Pulsed Source Current     | $I_{SM}$ | Diode in the MOSFET           | --   | --   | 28   |         |
| Diode Forward Voltage     | $V_{SD}$ | $I_S=7.0A, V_{GS}=0V$         | --   | --   | 1.4  | V       |
| Reverse Recovery Time     | $T_{rr}$ | $I_S=7.0A, V_{GS}=0V,$        | --   | 590  | --   | ns      |
| Reverse Recovery Charge   | $Q_{rr}$ | $di_F/dt=100A/\mu S$ (Note2)  | --   | 3.9  | --   | $\mu C$ |

### Notes:

1.  $L=30mH, I_{AS}=5.50A, V_{DD}=100V, R_G=20\Omega$ , starting  $T_{BJB}=25^\circ C$ ;
2. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ ;
3. Essentially independent of operating temperature.

**TYPICAL CHARACTERISTICS**

Figure 1. On-Region Characteristics

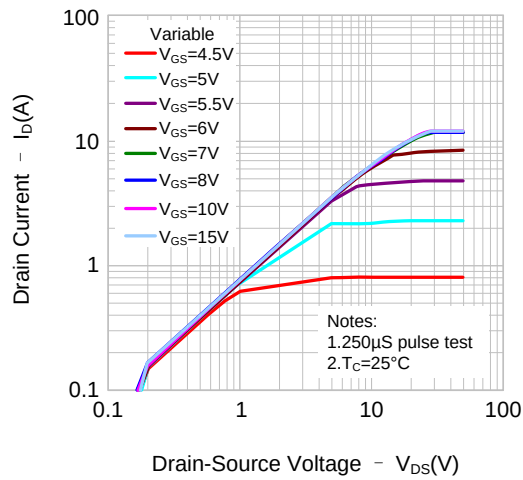


Figure 2. Transfer Characteristics

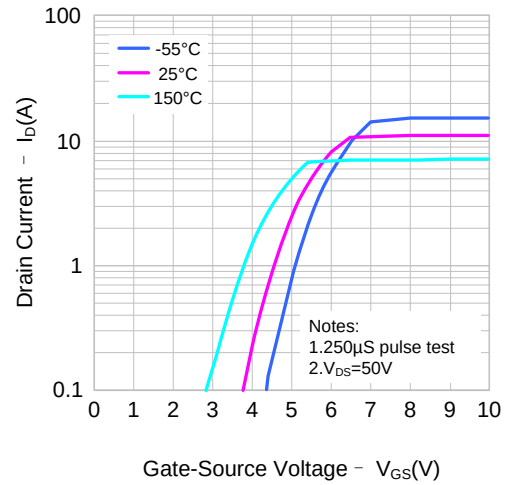


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

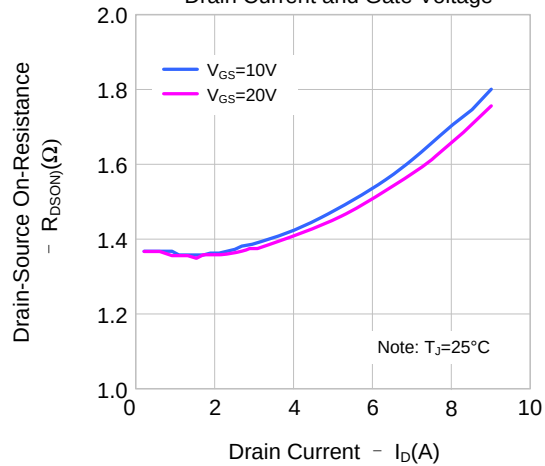


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

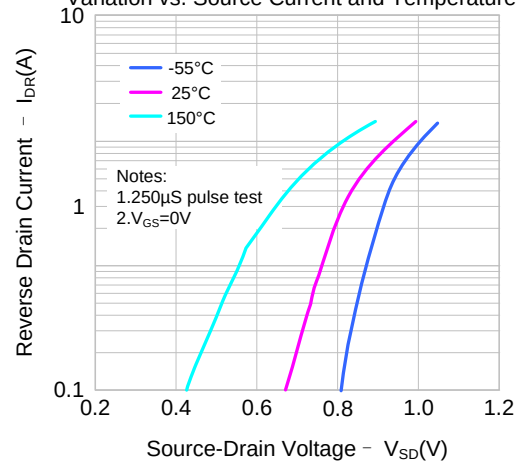


Figure 5. Capacitance Characteristics

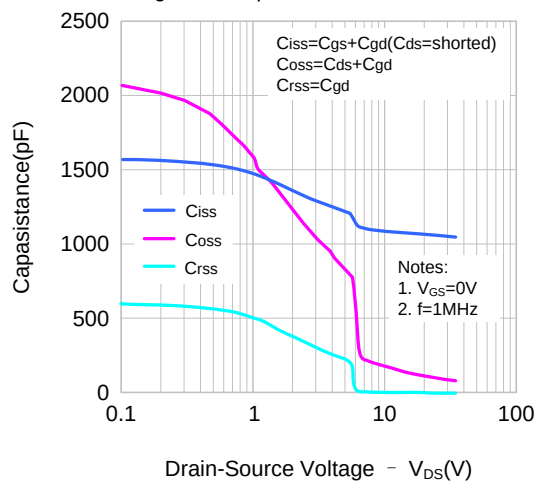
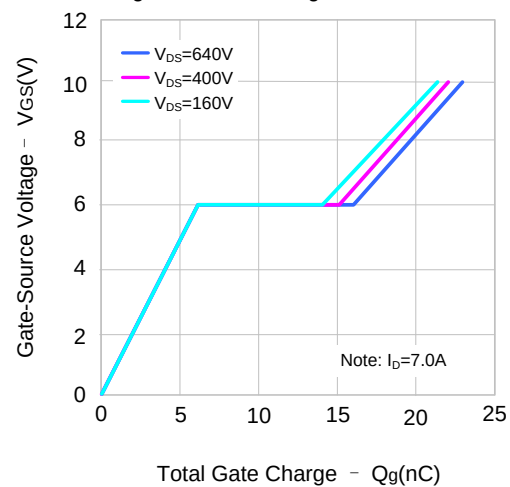


Figure 6. Gate Charge Characteristics



**TYPICAL CHARACTERISTICS(CONTINUED)**

Figure 7. Breakdown Voltage Variation vs. Temperature

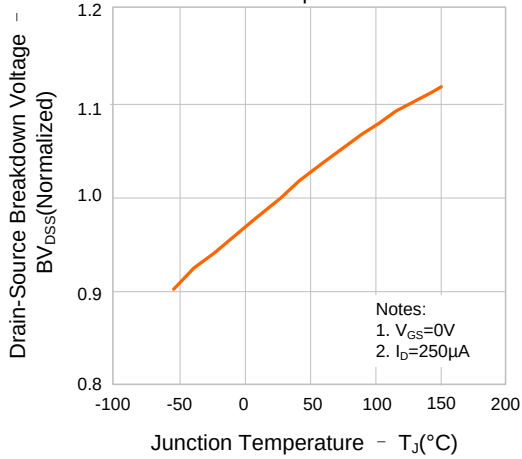


Figure 8. On-resistance Variation vs. Temperature

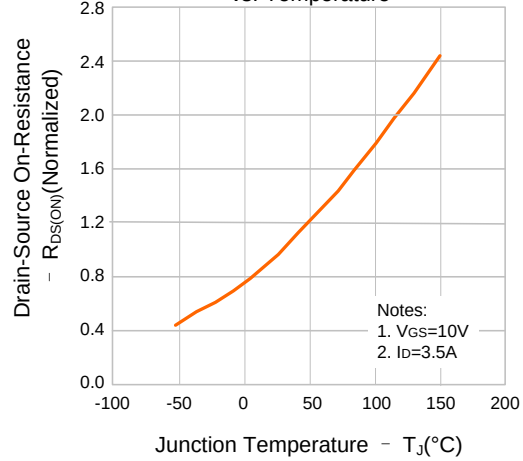


Figure 9-1. Max. Safe Operating Area(SVF7N80T)

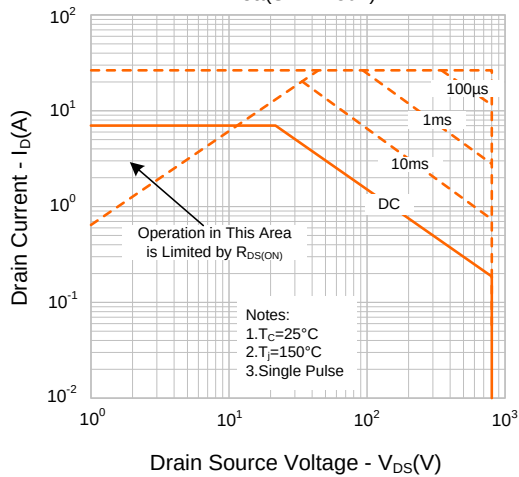


Figure 9-2. Max. Safe Operating Area(SVF7N80F/FD)

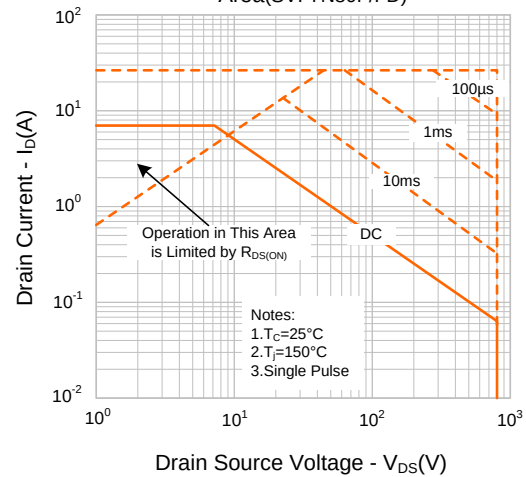


Figure 9-3. Max. Safe Operating Area(SVF7N80KL/K)

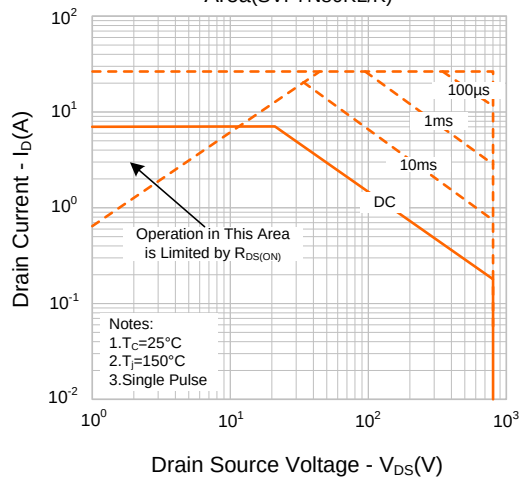
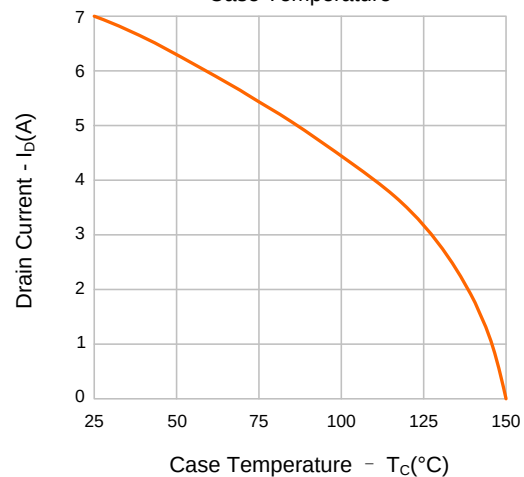
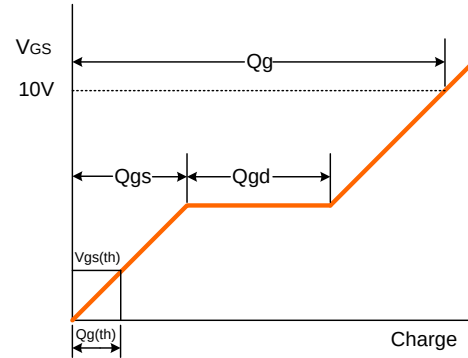
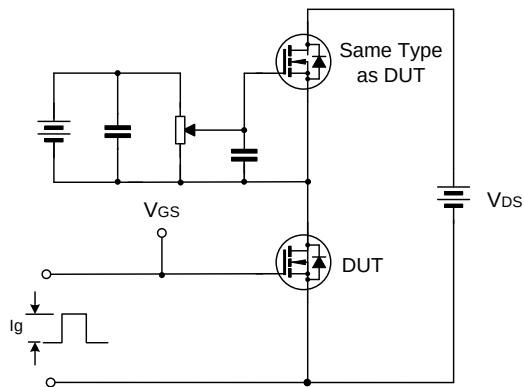


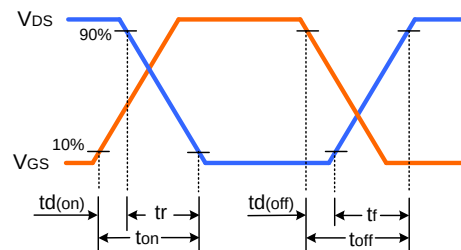
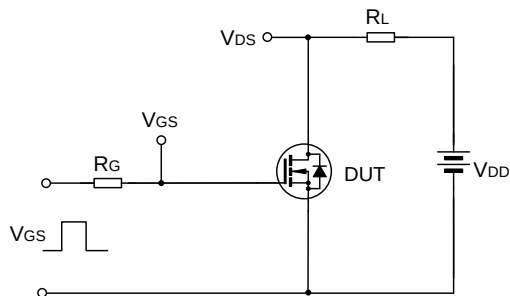
Figure 10. Maximum Drain Current vs. Case Temperature



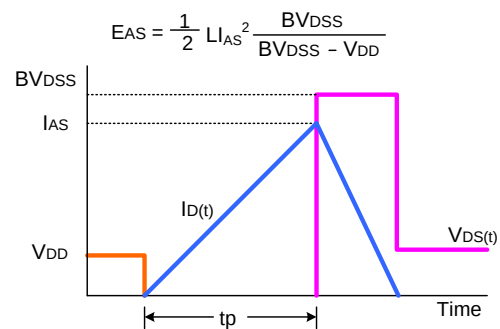
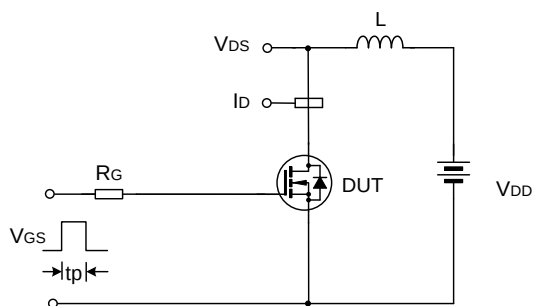
## TYPICAL TEST CIRCUIT



Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform

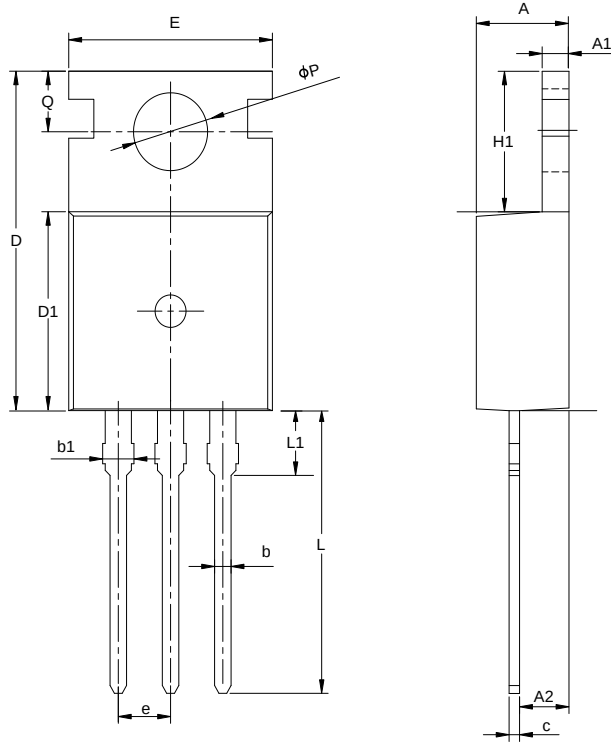


Unclamped Inductive Switching Test Circuit & Waveform

## PACKAGE OUTLINE

### TO-220-3L

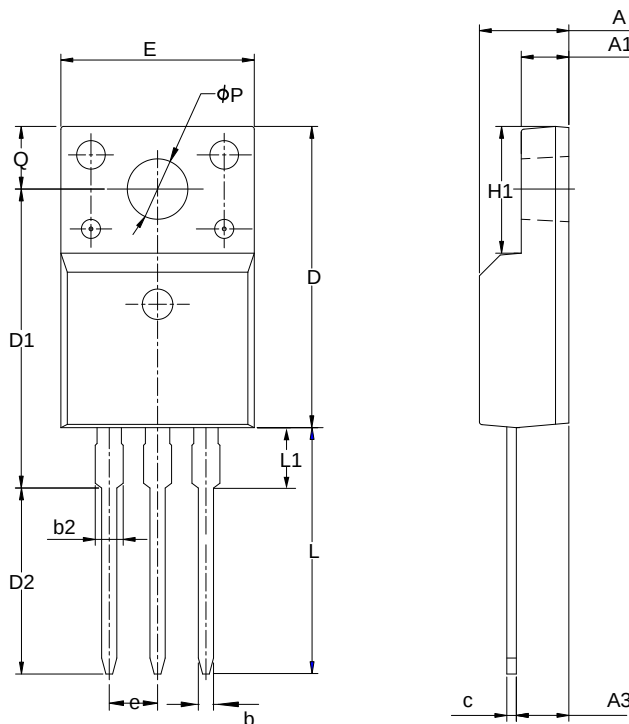
UNIT: mm



| SYMBOL   | MILLIMETER |       |       |
|----------|------------|-------|-------|
|          | MIN        | NOM   | MAX   |
| A        | 4.30       | 4.50  | 4.70  |
| A1       | 1.00       | 1.30  | 1.50  |
| A2       | 1.80       | 2.40  | 2.80  |
| b        | 0.60       | 0.80  | 1.00  |
| b1       | 1.00       | —     | 1.60  |
| c        | 0.30       | —     | 0.70  |
| D        | 15.10      | 15.70 | 16.10 |
| D1       | 8.10       | 9.20  | 10.00 |
| E        | 9.60       | 9.90  | 10.40 |
| e        | 2.54BSC    |       |       |
| H1       | 6.10       | 6.50  | 7.00  |
| L        | 12.60      | 13.08 | 13.60 |
| L1       | —          | —     | 3.95  |
| $\phi P$ | 3.40       | 3.70  | 3.90  |
| Q        | 2.60       | —     | 3.20  |

### TO-220F-3L

UNIT: mm

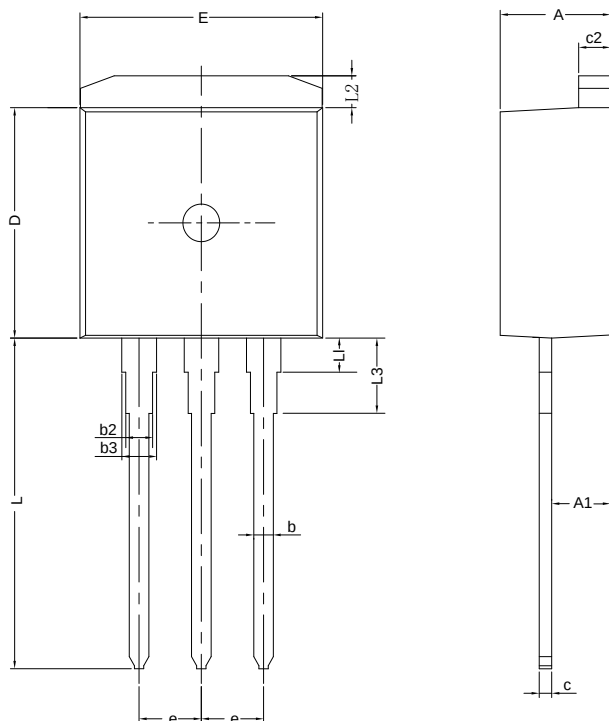


| SYMBOL   | MILLIMETER |       |       |
|----------|------------|-------|-------|
|          | MIN        | NOM   | MAX   |
| A        | 4.42       | 4.70  | 5.02  |
| A1       | 2.30       | 2.54  | 2.80  |
| A3       | 2.50       | 2.76  | 3.10  |
| b        | 0.70       | 0.80  | 0.90  |
| b2       | —          | —     | 1.47  |
| c        | 0.35       | 0.50  | 0.65  |
| D        | 15.25      | 15.87 | 16.25 |
| D1       | 15.30      | 15.75 | 16.30 |
| D2       | 9.30       | 9.80  | 10.30 |
| E        | 9.73       | 10.16 | 10.36 |
| e        | 2.54BSC    |       |       |
| H1       | 6.40       | 6.68  | 7.00  |
| L        | 12.48      | 12.98 | 13.48 |
| L1       | —          | —     | 3.50  |
| $\phi P$ | 3.00       | 3.18  | 3.40  |
| Q        | 3.05       | 3.30  | 3.55  |

## PACKAGE OUTLINE(CONTINUED)

TO-262L-3L

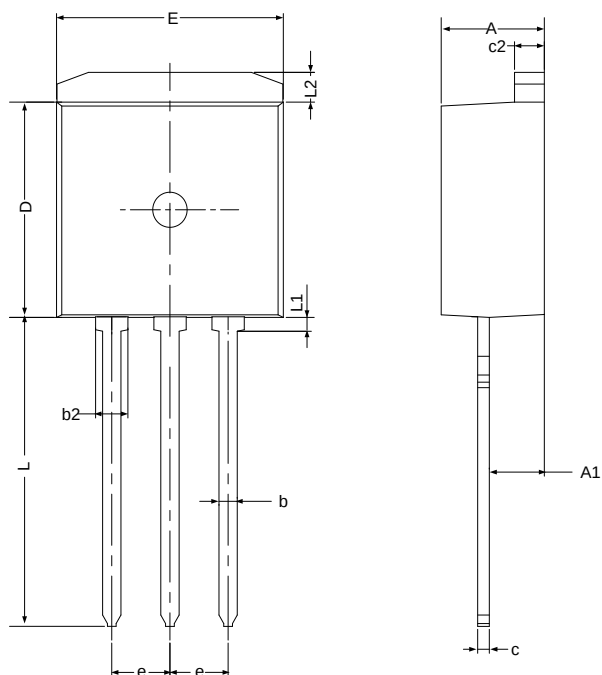
UNIT: mm



| SYMBOL | MILLIMETER |       |       |
|--------|------------|-------|-------|
|        | MIN        | NOM   | MAX   |
| A      | 4.30       | 4.50  | 4.70  |
| A1     | 2.20       | —     | 2.92  |
| b      | 0.71       | 0.80  | 0.88  |
| b2     | 0.90       | 1.01  | 1.08  |
| b3     | 1.20       | —     | 1.50  |
| c      | 0.34       | —     | 0.76  |
| c2     | 1.22       | 1.30  | 1.35  |
| D      | 8.38       | —     | 9.30  |
| E      | 9.80       | 10.16 | 10.54 |
| e      | 2.54 BSC   |       |       |
| L      | 12.80      | —     | 14.10 |
| L1     | 1.40       | 1.50  | 1.60  |
| L2     | 1.12       | —     | 1.42  |
| L3     | 3.00       | 3.20  | 3.40  |

TO-262-3L

UNIT: mm



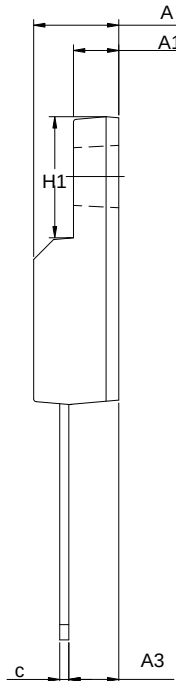
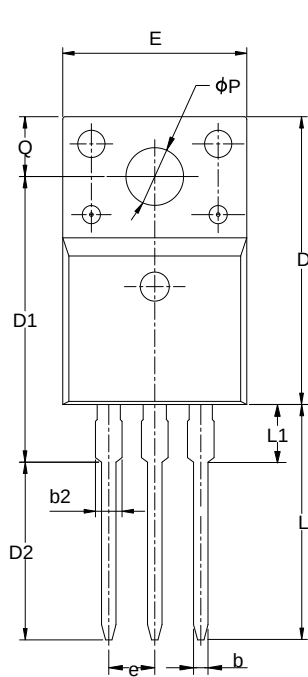
| SYMBOL | MILLIMETER |       |       |
|--------|------------|-------|-------|
|        | MIN        | NOM   | MAX   |
| A      | 4.30       | 4.50  | 4.70  |
| A1     | 2.20       | —     | 2.92  |
| b      | 0.71       | 0.80  | 0.90  |
| b2     | 1.20       | —     | 1.50  |
| c      | 0.34       | —     | 0.65  |
| c2     | 1.22       | 1.30  | 1.35  |
| D      | 8.38       | —     | 9.30  |
| E      | 9.80       | 10.16 | 10.54 |
| e      | 2.54 BSC   |       |       |
| L      | 12.80      | —     | 14.10 |
| L1     | —          | —     | 0.75  |
| L2     | 1.12       | —     | 1.42  |



## PACKAGE OUTLINE(CONTINUED)

TO-220FD-3L

UNIT: mm



| SYMBOL   | MILLIMETER |       |       |
|----------|------------|-------|-------|
|          | MIN        | NOM   | MAX   |
| A        | 4.42       | 4.70  | 5.02  |
| A1       | 2.30       | 2.54  | 2.80  |
| A3       | 2.50       | 2.76  | 3.10  |
| b        | 0.70       | 0.80  | 0.90  |
| b2       | —          | —     | 1.47  |
| c        | 0.35       | 0.50  | 0.65  |
| D        | 15.25      | 15.87 | 16.25 |
| D1       | 15.30      | 15.75 | 16.30 |
| D2       | 9.30       | 9.80  | 10.30 |
| E        | 9.73       | 10.16 | 10.36 |
| e        | 2.54BSC    |       |       |
| H1       | 6.40       | 6.68  | 7.00  |
| L        | 12.48      | 12.98 | 13.48 |
| L1       | —          | —     | 3.50  |
| $\Phi P$ | 3.00       | 3.18  | 3.40  |
| Q        | 3.05       | 3.30  | 3.55  |

### Important notice :

- The instructions are subject to change without notice! Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current.
- Our products are consumer electronic products, and / or civil electronic products.
- When using our products, please do not exceed the maximum rating of the products, otherwise the reliability of the whole machine will be affected. There is a certain possibility of failure or malfunction of any semiconductor product under specific conditions. The buyer is responsible for complying with safety standards and taking safety measures when using our products for system design, sample and whole machine manufacturing, so as to avoid potential failure risk that may cause personal injury or property loss.
- It is strongly recommended to identify the trademark when buying our products. Please contact us if there is any question.
- When exporting, using and reselling our products, buyer must comply with the international export control laws and regulations of China, the United States, the United Kingdom, the European Union and other countries & regions.
- Product promotion is endless, our company will wholeheartedly provide customers with better products!
- Website: <http://www.silan.com.cn>

---

|            |                                         |                |                                                               |
|------------|-----------------------------------------|----------------|---------------------------------------------------------------|
| Part No.:  | SVF7N80T/F/KL/K/FD                      | Document Type: | Datasheet                                                     |
| Copyright: | HANGZHOU SILAN MICROELECTRONICS CO.,LTD | Website:       | <a href="http://www.silan.com.cn">http://www.silan.com.cn</a> |

---

Rev.: 2.9

Revision History:

1. Deleted NOMENCLATURE
  2. Modify Important notice
- 

Rev.: 2.8

Revision History:

1. Add SVF7N80FD (to-220FD-3L) package
  2. Add parameters and curves with SVF7N80F
  3. Update corresponding electrical diagram and typical circuit diagram
  4. Modify NOMENCLATURE
  5. Modify TYPICAL TEST CIRCUIT
  6. Modify Important notice
- 

Rev.: 2.7

Revision History:

1. Add the package outline of TO-262-3L
- 

Rev.: 2.6

Revision History:

1. Add the package outline of TO-262L-3L
  2. Delete the package outline of TO-262-3L
- 

Rev.: 2.5

Revision History:

1. Update the package outline of TO-262-3L
  2. Add another 3D image of TO-220-3L
- 

Rev.: 2.4

Revision History:

1. Delete the package outline of TO-262L-3L
- 

Rev.: 2.3

Revision History:

1. Update the package outline of TO-262-3L
- 

Rev.: 2.2

Revision History:

1. Add the package outline of TO-262L-3L
- 

Rev.: 2.1

Revision History:

1. Modify the ordering information
  2. Modify the package outline of TO-262-3L
- 

Rev.: 2.0

Revision History:

1. Modify the ordering information
-

- 
2. Modify the package outline of TO-220-3L
- 

Rev.: 1.9

Revision History:

1. Modify the ordering information
- 

Rev.: 1.8

Revision History:

1. Modify the thermal characteristics
- 

Rev.: 1.7

Revision History:

1. Add the package of TO-262-3L
- 

Rev.: 1.6

Revision History:

1. Modify the ordering information
- 

Rev.: 1.5

Revision History:

1. Change the schematic diagram of MOS
  2. Modify the figure 7 and figure 8
- 

Rev.: 1.4

Revision History:

1. Modify the figure 7 and figure 8
- 

Rev.: 1.3

Revision History:

1. Modify the values of  $T_{rr}$  and  $Q_{rr}$
- 

Rev.: 1.2

Revision History:

1. Modify "ORDERING INFORMATION"
- 

Rev.: 1.1

Revision History:

1. Modify "PACKAGE OUTLINE"
- 

Rev.: 1.0

Revision History:

1. Initial release
- 
-